Absolute Maximum Ratings (Ta = 25°C)

	Characteristic	Symbol	Rating	Unit
	Forward current	I _{F(RMS)}	±50	mA
	Forward current detating (Ta ≥ 53°C)	ΔI _F /°C	-0.7	mA/°C
	Pulse forward current (Note 1)	IFP	±1	A
=	Diode power dissipation	PD	100	mW
	Diode power dissipation derating (Ta ≥ 53°C)	ΔP _D /°C	-1.39	mW/°C
	Junction temperature	Tj	125	°C
	Collector-emitter voltage	VCEO	80)) v
	Emitter-collector voltage	V _E CO	7	V
ctor	Collector current	Ic	(50)	mA
Detector	Power dissipation	PC	150	mW
	Power dissipation derating (Ta ≥ 25°C)	ΔP _C /°C	-1:5	mW/°C
	Junction temperature	T _j	125	°C
Storage temperature range		T _{stg}	-55 to 125	0,0
Operating temperature range		T _{opr}	-55 to 100	Ç
Lead soldering temperature (10 s)		T _{sol}	260	°€
Total package power dissipation		RI	200) mW
Total package power dissipation derating (Ta ≥ 25°C)		ΔPT/°C	-2.0	mW/°C
Isola	ation voltage (AC, 60 s, R.H. ≤ 60 %) (Note 2)	BVs	3750	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Pulse width ≤ 100 µs, f = 100 Hz

Note 2: Device considered a two terminal device: Pins 1 and 3 shorted together and 4 and 6 shorted together.

Recommended Operating Conditions

Characteristic	Symbol	Min	Тур.	Max	Unit
Supply voltage	Vcc	_	5	48	V
Forward current	IF(RMS)	_	16	20	mA
Collector current	Ic	_	1	10	mA
Operating temperature	T _{opr}	-25	_	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

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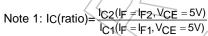
Electrical Characteristics (Ta = 25°C)

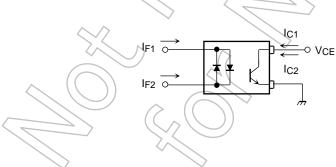
Characteristic Symbol Test Condition		Test Condition	Min	Тур.	Max	Unit	
Ω	Forward voltage	VF	I _F = ±10 mA		1.15	1.3	V
LED	Capacitance	Ст	V = 0 V, f = 1 MHz	_	60	_	pF
	Collector-emitter breakdown voltage	V _(BR) CEO	I _C = 0.5 mA		_	_	V
٦.	Emitter-collector breakdown voltage	V _{(BR)ECO}	I _E = 0.1 mA		_		V
Detector	Oallastandada assassa	VCE = 48 V (ambient light below 1000 lx) (Note 1)) }	0.01 (2)	0.1 (10)	μΑ	
	Collector dark current	V _{CE} = 48 V, Ta = 85°C	V _{CE} = 48 V, Ta = 85°C (ambient light below 1000 ℓx) (Note 1)	_	2 (4)	50 (50)	μΑ
	Capacitance (collector to emitter)	CCE	V = 0 V, f = 1 MHz	_	10	_	pF

Note 1: Please use standard electric lamp to light up the device's marking surface.

Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Current transfer ratio	IC/IF	$I_F = \pm 5 \text{ mA}, V_{CE} = 5 \text{ V}$	50)	_	600	. %
Current transfer fatto	IC/IF	Rank GB	100	_	600	70
Saturated CTR	lo/ler	$IF = \pm 1 \text{ mA}, V_{CE} = 0.4 \text{ V}$) —	60	_	%
Saturated CTK	IC/IF(sat)	Rank GB	30	_		70
		$I_C = 2.4 \text{ mA}, I_F = \pm 8 \text{ mA}$	_	_	0.4	
Collector-emitter saturation voltage	VCE (sat)	$I_C = 0.2 \text{ mA}, I_F = \pm 1 \text{ mA}$	_	0.2		V
	7	Rank GB	_	_	0.4	
Off-state collector current	Ic(off)	V _F = ± 0.7 V, V _{CE} = 48 V	_	1	10	μΑ
CTR symmetry	IC(ratio)	$I_C (I_F = -5 \text{ mA})/I_C (I_F = 5 \text{ mA})$ (Note 1)	0.33	1	3	_





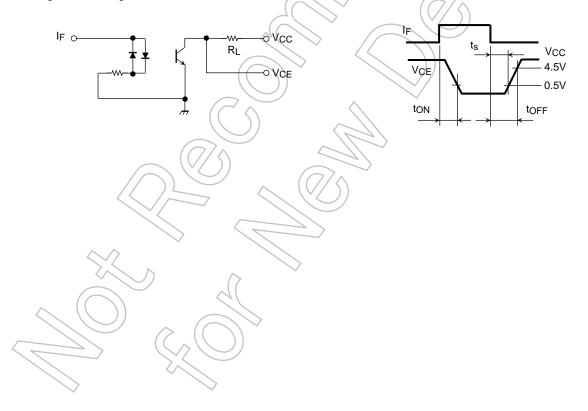
Isolation Characteristics (Ta = 25°C)

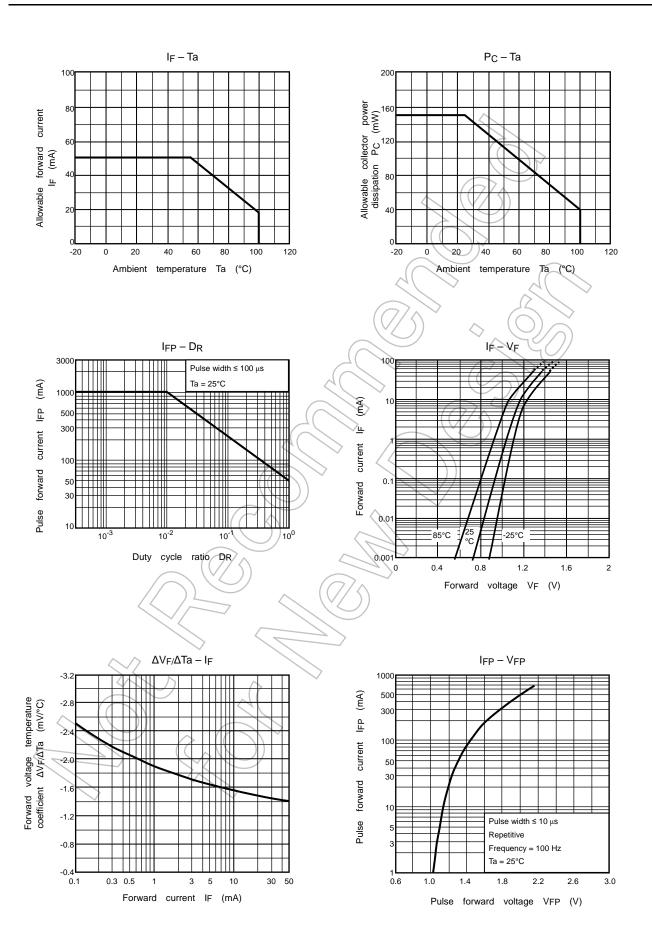
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	Cs	V _S = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation resistance	Rs	V _S = 500 V, R.H. ≤ 60 %	5×10 ¹⁰	10 ¹⁴	_	Ω
Isolation voltage	BVS	AC, 60 s	3750	_	_	V _{rms}

Switching Characteristics (Ta = 25°C)

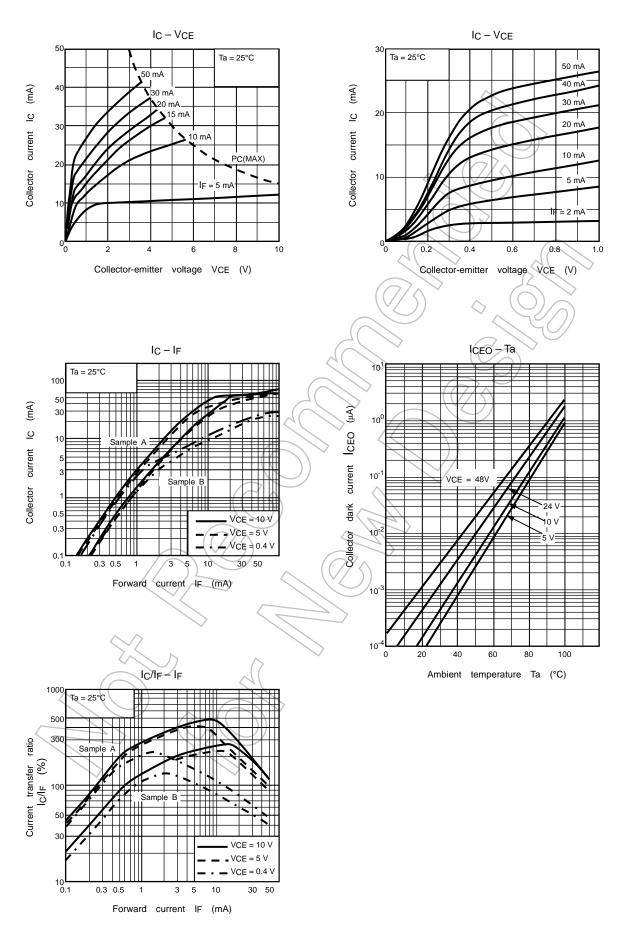
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Rise time	t _r		_	2	_	
Fall time	t _f	V _{CC} = 10 V, I _C = 2 mA	_	3	_	
Turn-on time	ton	R _L = 100 Ω		7/3	\rightarrow	μS
Turn-off time	tOFF		756	3	· –	
Turn-on time	ton		16	2)2	_	
Storage time	ts	$R_L = 1.9 \text{ k}\Omega$ (Fig.1) $V_{CC} = 5 \text{ V, IF} = \pm 16 \text{ mA}$		25//	_	μS
Turn-off time	toff			40	_	

Fig. 1: Switching time test circuit

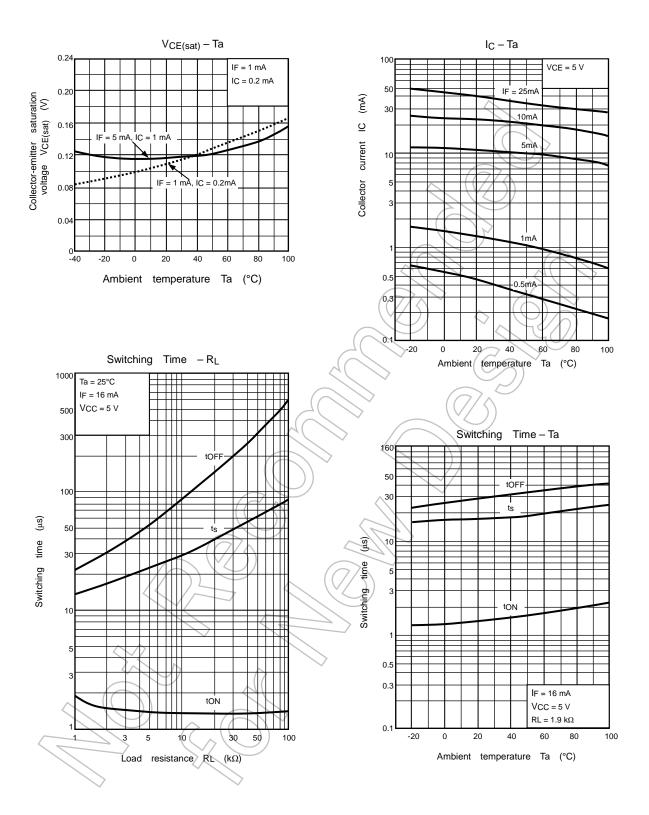




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